As a below named inventor, I hereby declare that:

My residence post office address and citizenship are as stated below next to my name,

I believe the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is

sought on the invention ENTITLED:

the specification of which is attached hereto. X was filed on 14 October 1999 as International Application Serial No. PCT/JP99/056 with amendment(s) through (if applicable, give dates). I hereby state that I have reviewed and understand the contents of the above-identified specificat the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all information to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56. To be material to patentability as defined in Title 37, United States Code, § 119 of any foreign I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application for applica	ion, including
X was filed on 14 October 1999 as International Application Serial No. PCT/JP99/050 with amendment(s) through I hereby state that I have reviewed and understand the contents of the above-identified specificat the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all information to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56.	ion, including
(if applicable, give dates). I hereby state that I have reviewed and understand the contents of the above-identified specificat the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all information to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56.	ion, including
I hereby state that I have reviewed and understand the contents of the above-identified specificat the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all information is acknowledge the duty to disclose to the United States Patent Regulations, Sec. 1.56.	ion, including
the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all informations. Sec. 1.56. to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56.	.ion, including
the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose to the United States Patent and Trademark Office all informations. Sec. 1.56. to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56.	
to be material to patentability as defined in little 37, code 37, listed States Code & 119 of any foreign	n known to me
to be material to Farmer and Torrelan	annlication(s)
I hereby claim foreign priority benefits under little 35, unted states do any foreign application f	or patent or
for patent or inventor's certificate listed below and have also identified below the priority is claimed:	•
Prior Foreign Application(s) [list additional applications on separate page.	
Number: Country: Filed (Day/Month/Year):	<u>No</u>
P10-293830 Japan 15 October 1998 X	
P10-296942 Japan 19 October 1998 X	
P10-313020 Japan 04 November 1998 X	
P11-103337	
PCT/JP99/05689 PCT 14 October 1999 X	
I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application is not disclosed in the	
I hereby claim the benefit under little 33, united states on this application is not disclosed in the below and, insofar as the subject matter of each of the claims of this application is not disclosed in the below and, insofar as the subject matter of each of the graph of Title 35, United States Code § 112, I states application in the manner provided by the first paragraph of Title 35, United States Code § 112, I duty to disclose to the United States Patent and Trademark Office all information known to me to be materially as defined in Title 37, Code of Federal Regulations, Sec. 1.56, which became available between the prior application and the national or PCT international filing date of this application:	ial to
Prior U.S. Application(s) [list additional applications on separate page]: Status (natented panding abandoned):	•
Appril. 3ct : Italias.	
I hereby appoint <u>WILLIAM S. FROMMER</u> , Registration No. <u>25,506</u> , and <u>DENNIS M. SMID</u> , Registrat or their duly appointed associate, my attorneys, with full power of substitution and revocation, to prosect application, to make alterations and amendments therein, to file continuation and divisional applications are to be directed to the Courts in the Patent and Trademark Office and in the Courts in the Courts in the Patent, and specify that all communications about the application are to be directed to the following the address:	thereof, to
UILLIAM S. FROMMER . Esq. Direct all telephone calls to:	
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745 Fifth Avenue to the attention of: New York, New York 10151 WILLIAM S. FROMMER	
new joint that all statements made berein of my own knowledge are true and that all statements	ments made on
information and belief are believed to be true; and further that these statements were made with the know willful false statements and the like so made are punishable by fine or imprisonment, or both, under Sect Title 18 of the United States Code and that such willful false statements may jeopardize the validity of or any patent issued thereon.	ion 1001 of the application
Minako Malistyama i Date: 10 Okt	ne .2000
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Tolaro 141 0001 Japan	122.uk
Note: In order to qualify for reduced fees available to Small Entities, each inventor and any other ind having rights to the invention must also sign an appropriate separate "Verified Statement (Declaration) Supporting a Claim by Another for Small Entity Status" form [e.g. for Independent Inventor, Small Busin	

Note: A post office address must be provided for each inventor.

Nonprofit Organization, individual Non-Inventor].

FLH File No.

ADDITIONAL INVENTORS	
	16 June 2000
7 hi 14-0	Date:
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Citizenship:	27 June 20w
Parry Kitamira	Date:
	•
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Residence: Janan	
Citizenship:	Date: 16, June, 2000
Myra Delog - D	Date:
Signature: (if any): Yoshitomo OSAWA	· ·
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Total ON TO	Date:
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· ·	Date:
	
Signature: Full name of 8th joint inventor (if any):	
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